SURFACE MOUNT FAST RECOVERY RECTIFIERS

FEATURES:

- Plastic package has Underwriters
- Flammability Classification 94V-0
- For surface mounted applications in order to optimize bord space
- Low profile package
- Built-in strain relief, ideal for automated placement
- Fast switching for high efficiency
- Glass passivated chip junction
- High temperature soldering:
 250 °C /10 seconds at terminals

MECHANICAL DATA

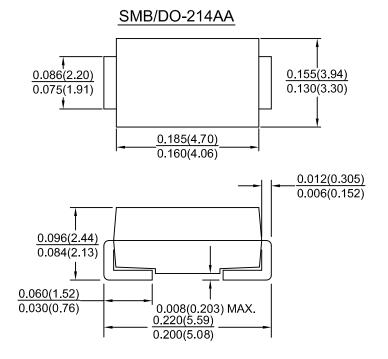
Case: JEDEC DO-214AA molded plastic over passivated chip

Terminals: Solder plated, solderable perMIL-STD-750,

Method 2026

Polarity: Color band denotes cathode end

Weight: 0.093 grams



Dimensions in inches and (millimeters)

MAXIMUM RATINGS AND ELECTRICAL CHARACTERISTICS

Rating at 25° C ambient temp. unless otherwise specified.

Single phase, half sine wave, 60 Hz, resistive or inductive load.

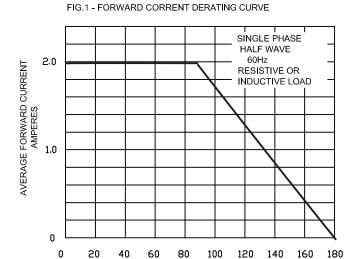
For capacitive load, derate current by 20 %.

Characteristic		Symbol	RS2A	RS2B	RS2D	RS2G	RS2J	RS2K	RS2M	Units
Maximum recurrent peak reverse voltage		VRRM	50	100	200	400	600	800	1000	Volts
Maximum RMS voltage		VRMS	35	70	140	280	420	560	7000	Volts
Maximum DC blocking voltage		VDC	50	100	200	400	600	800	1000	Volts
Maximum average forward rectified current at Ta=90°C		lo	2.0							Amp
Peak forward surge current 8.3ms single half sine-wave superimposed on rated load(JEDEC Method)		IFSM	50							Amps
Maximum instantaneous forward voltage at 2.0A		VF	1.30							Volts
Maximum DC reverse current at rated DC blocking voltage	Ta=25 ° C Ta=125 ° C	lR	5.0 200					μA		
Maximum reverse recovery time	(Note1)	trr		150)		250	500)	nS
Operating and storage temperature range		TJ,Tstg	-65 to +150							•c

NOTES:

- (1) Reverse recovery test condition: I F=0.5A, IR=1.0A, Irr=0.25A
- (2) Measured at 1.0 MHz and applied reverse voltage of 4.0 Volts
- (3) Thermal resistance from Junction to lead mounted on P.C.B. with 0.2×0.2 " (5.0x5.0mm) copper Pad areas

RATINGS AND CHARACTERISTIC CURVES RS2A THRU RS2M



AMBIENT TEMPERATURE. *C

